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6715/67458

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To the Honorable Commissioner of Patents and Trademark

1. Name of conveying party(ies):

Katsuyoshi Orita, Masamichi Morioka & Hiroshi Yoneyama

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of Conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: April 22, 1999

2. Name and address of receiving party(ies):

Name: Sony Corporation

Internal Address:

Street Address: 7-35 Kitashinagawa 6-chome
Shinagawa-ku, Tokyo, Japan

Additional name(s) & address(es) attached ☒ Yes ☐ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

09/147,665

Additional numbers attached?

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Jay H. Maioli

Internal Address: Cooper & Dunham LLP

Street Address: 1185 Avenue of the Americas

City: New York State: New York ZIP: 10036

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00 E

☒ Enclosed

☐ Authorized to be charged to deposit account

8. Deposit account number:

03-3125 (Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jay H. Maioli

Name of Person Signing

Jay H. Maioli
Signature

June 10, 1999

Date

Total Number of pages comprising cover sheet: 2

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PATENT
REEL: 010076 FRAME: 0995

6715/57458

2. (continued)

YAZAKI INDUSTRIAL CHEMICAL CO., LTD.
24-1, Oshika 2-chome, Shizuoka-shi
Shizuoka 422-8021, JAPAN

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in _____
COMPONENT HOUSING DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001, Japan

and
YAZAKI INDUSTRIAL CHEMICAL CO., LTD., a Japanese corporation with offices at 24-1, Oshika 2-chome, Shizuoka-shi, Shizuoka 422-8021, Japan

(hereinafter reference as ASSIGNEE) are
desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereof;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereof;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number_____, Filing Date_____.

This assignment executed on the dates indicated below.

Katsuyoshi ORITA
Name of first or sole inventor
Aichi, Japan
Residence of first or sole inventor
Katsuyoshi Orita
Signature of first or sole inventor

Execution date of U.S. Patent Application

April 22, 1999
Date of this assignment

Masamichi MORIOKA
Name of second inventor
Shizuoka, Japan
Residence of second inventor
Masamichi Morioka
Signature of second inventor

Execution date of U.S. Patent Application

April 22, 1999
Date of this assignment

Hiroshi YONEYAMA
Name of third inventor
Aichi, Japan
Residence of third inventor
Hiroshi Yoneyama
Signature of third inventor

Execution date of U.S. Patent Application

April 22, 1999
Date of this assignment

Name of fourth inventor

Residence of fourth inventor

Signature of fourth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of fifth inventor

Residence of fifth inventor

Signature of fifth inventor

Execution date of U.S. Patent Application

Date of this assignment